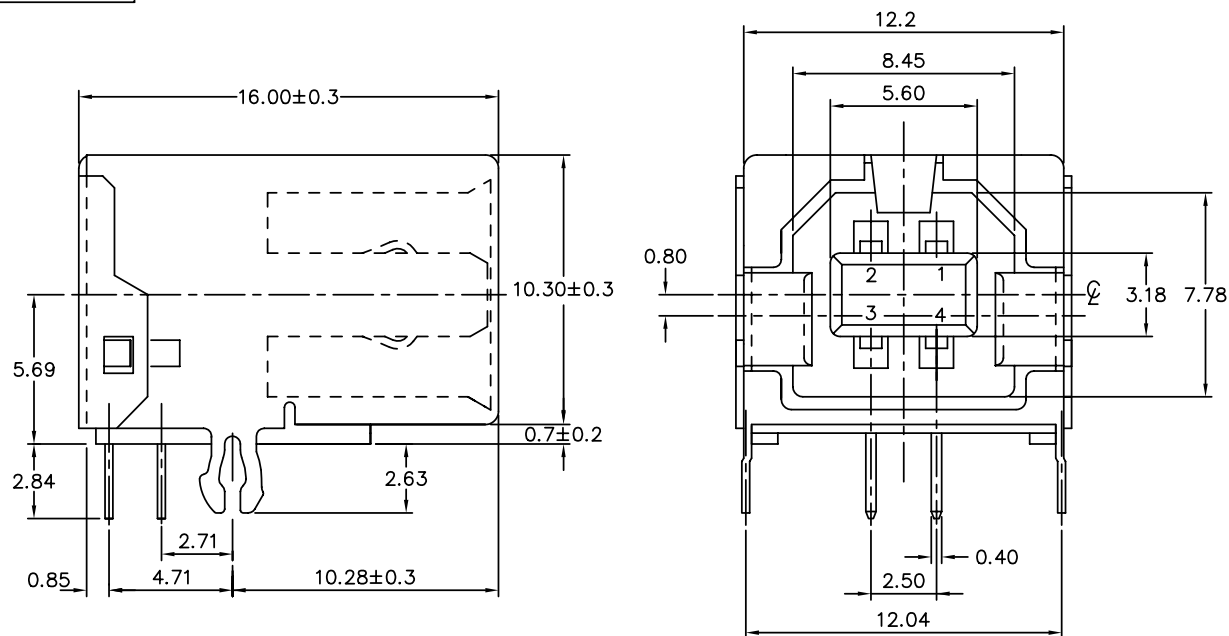
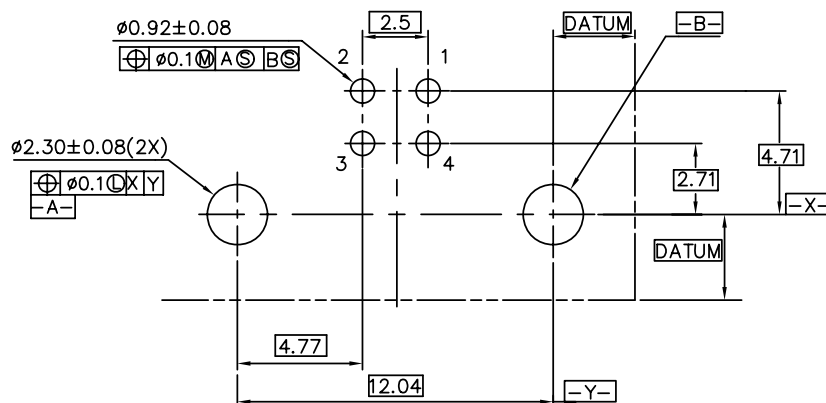


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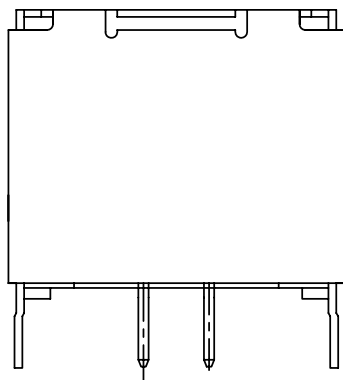
61729 - X X X X X P S LF

LEAD FREE OPTION

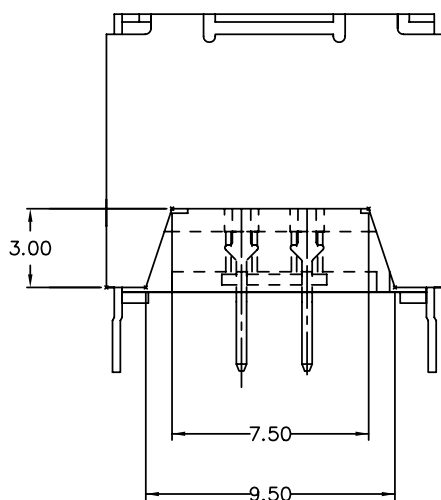


P.C. BOARD LAYOUT

mat'l. code				surface ☒ tolerance		projection		product family	
				ISD 1301 ☒ ISD 406 ISD 1101				USB2.0	
ltn		ecn nldr		date		tolerances unless otherwise specified		title	
S		N05-0242		PH		08/22/05		angle ☐ 0.0 ± 0.3	
T		N06-0103		HB		04/15/06		linear ☐ 0.00 ± 0.20	
U		N08-0238		R,B		11/3/08		circular ☐ 0 ± 2	
V		N08-0264		R,B		12/08/08		scale 4:1	
W		N08-0264		R,B		12/08/08		dwg no	
								sheet 1 of 2	
								size	
								A4	
								type	
								Product Customer Drawing	
sheet		revision		W					
index		sheet		1-2					



TYPE "1" FULL BACK



TYPE "2" PARTIAL BACK

NOTES:

1. MATERIAL:
SHIELD & CONTACTS: COPPER ALLOY
HOUSING: UL 94V-0 ,HIGHT TEMPERATURE THERMOPLASTIC.
COLOR: SEE PRODUCT NUMBER CODE.
2. PLATING: SEE PRODUCT NUMBER CODE.
SHIELD: BRIGHT TIN
NICKEL UNDERPLATE.
3. DATUMS & BASIC DIMENSIONS TO BE DETERMINED BY CUSTOMER
4. RECOMMENDED BOARD THICKNESS IS 1.57 mm (.062)
5. PACKING STANDARD GS-14-920 WILL BE APPLIED FOR LEAD FREE P/N'S
6. FOR LEAD FREE P/N, THE PRODUCT MEET EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATION AS DESCRIBED IN GS-22-008
7. FOR LEAD FREE P/N'S, THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A CONVECTION, INFRO-RED OR VAPOR PHASE REFLOW OVEN.
8. THE PART CAN BE USED FOR PIP PROCESS.

mat'l. code	surface	tolerance	projection	product family
	ISO 1301 ✓	ISO 406 ISO 1101	mm	USB2.0
ltn ecn nodr date	tolerances unless otherwise specified	mm	title	
- - -	0.0±0.3	mm	USB RECEPTACLE B TYPE	
	0.00±0.20	mm		
	0°±2'	0.000±0.10	scale 4:1	
	dr LQ.LEI 2013-12-10		dwg no	sheet 2 of 2 size
	enr LQ.LEI 2013-12-10		61729	A4
	chr RICK BIAN 2013-12-10		type	Product Customer Drawing
	appd RICK BIAN 2013-12-17			
sheet	revision			
index	sheet -			